Gerhard Dehm

List of Publications by Citations

357 papers	9,298 citations	48 h-index	80 g-index
367 ext. papers	10,642 ext. citations	6 avg, IF	6.53 L-index

#	Paper	IF	Citations
357	A further step towards an understanding of size-dependent crystal plasticity: In situ tension experiments of miniaturized single-crystal copper samples. *Acta Materialia*, **2008**, 56, 580-592	8.4	396
356	In situ observation of dislocation nucleation and escape in a submicrometre aluminium single crystal. *Nature Materials*, **2009**, 8, 95-100	27	355
355	FIB damage of Cu and possible consequences for miniaturized mechanical tests. *Materials Science & Engineering A: Structural Materials: Properties, Microstructure and Processing*, **2007**, 459, 262-272	5.3	346
354	Observation of giant diffusivity along dislocation cores. *Science*, **2008**, 319, 1646-9	33.3	275
353	Determination of Mechanical Properties of Copper at the Micron Scale. *Advanced Engineering Materials*, **2006**, 8, 1119-1125	3.5	174
352	Overview on micro- and nanomechanical testing: New insights in interface plasticity and fracture at small length scales. *Acta Materialia*, **2018**, 142, 248-282	8.4	170
351	Trends in the Development of New Mg Alloys. *Annual Review of Materials Research*, **2008**, 38, 505-533	12.8	169
350	Micro-compression testing: A critical discussion of experimental constraints. *Materials Science & Engineering A: Structural Materials: Properties, Microstructure and Processing*, **2009**, 505, 79-87	5.3	164
349	A comparative micro-cantilever study of the mechanical behavior of silicon based passivation films. *Thin Solid Films*, **2009**, 518, 247-256	2.2	163
348	Importance and Challenges of Electrochemical in Situ Liquid Cell Electron Microscopy for Energy Conversion Research. *Accounts of Chemical Research*, **2016**, 49, 2015-22	24.3	136
347	Miniaturized single-crystalline fcc metals deformed in tension: New insights in size-dependent plasticity. *Progress in Materials Science*, **2009**, 54, 664-688	42.2	134
346	Cyclic deformation of polycrystalline Cu films. *Philosophical Magazine*, **2003**, 83, 693-710	1.6	110
345	Bidirectional Transformation Enables Hierarchical Nanolaminate Dual-Phase High-Entropy Alloys. *Advanced Materials*, **2018**, 30, e1804727	24	110
344	Interface controlled plasticity in metals: dispersion hardening and thin film deformation. *Progress in Materials Science*, **2001**, 46, 283-307	42.2	106
343	Can microscale fracture tests provide reliable fracture toughness values? A case study in silicon. *Journal of Materials Research*, **2015**, 30, 686-698	2.5	105
342	Grain refinement in □TiAl-based alloys by solid state phase transformations. *Intermetallics*, **2006**, 14, 1380-1385	3.5	104
341	Differences in deformation behavior of bicrystalline Cu micropillars containing a twin boundary or a large-angle grain boundary. *Acta Materialia*, **2014**, 73, 240-250	8.4	101

340	In situ TEM straining of single crystal Au films on polyimide: Change of deformation mechanisms at the nanoscale. *Acta Materialia*, **2007**, 55, 5558-5571	8.4	101
339	Growth and structure of copper thin films deposited on (0001) sapphire by molecular beam epitaxy. *The Philosophical Magazine: Physics of Condensed Matter B, Statistical Mechanics, Electronic, Optical and Magnetic Properties*, **1995**, 71, 1111-1124		101
338	Superlattice effect for enhanced fracture toughness of hard coatings. *Scripta Materialia*, **2016**, 124, 67-70	3.6	98
337	Adhesion energies of Cr thin films on polyimide determined from buckling: Experiment and model. *Acta Materialia*, **2010**, 58, 5520-5531	8.4	97
336	Parallel glide: unexpected dislocation motion parallel to the substrate in ultrathin copper films. *Acta Materialia*, **2003**, 51, 4471-4485	8.4	93
335	TEM investigations of the structural evolution in a pearlitic steel deformed by high-pressure torsion. *Metallurgical and Materials Transactions A: Physical Metallurgy and Materials Science*, **2006**, 37, 1963-1968	2.3	92
334	Small-scale plasticity in thin Cu and Al films. *Microelectronic Engineering*, **2003**, 70, 412-424	2.5	89
333	Creep behaviour and related high temperature microstructural stability of Ti46Al5Nb sheet material. *Intermetallics*, **2005**, 13, 515-524	3.5	75
332	Work hardening in micropillar compression: In situ experiments and modeling. *Acta Materialia*, **2011**, 59, 3825-3840	8.4	73
331	Growth and microstructural stability of epitaxial Al films on (0001) Al2O3 substrates. *Acta Materialia*, **2002**, 50, 5021-5032	8.4	73
330	On the importance of sample compliance in uniaxial microtesting. *Scripta Materialia*, **2009**, 60, 148-151	5.6	69
329	Crystal rotation in Cu single crystal micropillars: In situ Laue and electron backscatter diffraction. *Applied Physics Letters*, **2008**, 92, 071905	3.4	67
328	In situ TEM study of microplasticity and Bauschinger effect in nanocrystalline metals. *Acta Materialia*, **2010**, 58, 4772-4782	8.4	66
327	Fracture and Delamination of Chromium Thin Films on Polymer Substrates. *Metallurgical and Materials Transactions A: Physical Metallurgy and Materials Science*, **2010**, 41, 870-875	2.3	66
326	Observations of grain-boundary phase transformations in an elemental metal. *Nature*, **2020**, 579, 375-378	50.4	65
325	Mechanical Size-Effects in Miniaturized and Bulk Materials. *Advanced Engineering Materials*, **2006**, 8, 1033-1045	3.5	64
324	Quasi-crystalline grain-boundary phase in the magnesium die-cast alloy ZA85. *Scripta Materialia*, **2001**, 45, 517-524	5.6	64
323	Interface fracture properties of thin films studied by using the micro-cantilever deflection technique. *Surface and Coatings Technology*, **2009**, 204, 878-881	4.4	62

322	Electron-energy-loss spectroscopy studies of Cu-Al2O3 interfaces grown by molecular beam epitaxy. *Philosophical Magazine A: Physics of Condensed Matter, Structure, Defects and Mechanical Properties*, **1998**, 78, 439-465		62
321	Gold-Palladium Bimetallic Catalyst Stability: Consequences for Hydrogen Peroxide Selectivity. *ACS Catalysis*, **2017**, 7, 5699-5705	13.1	58
320	Nanometer-scaled lamellar microstructures in Ti-45Al-7.5Nb-(0; 0.5)C alloys and their influence on hardness. *Intermetallics*, **2008**, 16, 868-875	3.5	58
319	In situ transmission electron microscopy study of dislocations in a polycrystalline Cu thin film constrained by a substrate. *Applied Physics Letters*, **2000**, 77, 1126-1128	3.4	58
318	The influence of a brittle Cr interlayer on the deformation behavior of thin Cu films on flexible substrates: Experiment and model. *Acta Materialia*, **2015**, 89, 278-289	8.4	56
317	Yield stress influenced by the ratio of wire diameter to grain size – a competition between the effects of specimen microstructure and dimension in micro-sized polycrystalline copper wires. *Philosophical Magazine*, **2012**, 92, 3243-3256	1.6	55
316	Texture transition in Cu thin films: Electron backscatter diffraction vs. X-ray diffraction. *Acta Materialia*, **2006**, 54, 3863-3870	8.4	55
315	Electron Energy-Loss Near-Edge Structure of Metal-Alumina Interfaces. *Microscopy Microanalysis Microstructures*, **1995**, 6, 19-31		54
314	In situ transmission electron microscopy study of thermal-stress-induced dislocations in a thin Cu film constrained by a Si substrate. *Materials Science & Engineering A: Structural Materials: Properties, Microstructure and Processing*, **2001**, 309-310, 468-472	5.3	53
313	The influence of chromium addition on the toughness of Ni-Al2O3 interfaces. *Acta Materialia*, **1997**, 45, 3503-3513	8.4	52
312	Strain-Induced Asymmetric Line Segregation at Faceted Si Grain Boundaries. *Physical Review Letters* , **2018**, 121, 015702	7.4	50
311	Growth and structure of internal Cu/Al2O3 and Cu/Ti/Al2O3 interfaces11Paper presented at Sympos. Synergistic Synthesis of Inorganic Materials, March 1996, Schlo-Ringberg, Germany.. *Acta Materialia*, **1998**, 46, 759-772	8.4	49
310	Deformation-Induced Martensite: A New Paradigm for Exceptional Steels. *Advanced Materials*, **2016** , 28, 7753-7	24	48
309	Designed fully lamellar microstructures in a -TiAl based alloy: adjustment and microstructural changes upon long-term isothermal exposure at 700 and 800°C. *Materials Science & Engineering A: Structural Materials: Properties, Microstructure and Processing*, **2002**, 329-331, 124-129	5.3	48
308	Overview on established and novel FIB based miniaturized mechanical testing using in-situ SEM. *International Journal of Materials Research*, **2009**, 100, 1074-1087	0.5	47
307	Impact of instrumental constraints and imperfections on the dislocation structure in micron-sized Cu compression pillars. *Acta Materialia*, **2011**, 59, 5618-5626	8.4	44
306	Synthesis of analytical and high-resolution transmission electron microscopy to determine the interface structure of Cu/Al2O3. *Ultramicroscopy*, **1997**, 67, 207-217	3.1	44
305	Nanostructure and mechanical behavior of metastable Cu-Cr thin films grown by molecular beam epitaxy. *Acta Materialia*, **2015**, 83, 318-332	8.4	43

304	Unveiling the Re effect in Ni-based single crystal superalloys. *Nature Communications*, **2020**, 11, 389	17.4	42
303	Microscale Fracture Behavior of Single Crystal Silicon Beams at Elevated Temperatures. *Nano Letters*, **2016**, 16, 7597-7603	11.5	42
302	Dislocation-induced crystal rotations in micro-compressed single crystal copper columns. *Journal of Materials Science*, **2008**, 43, 2503-2506	4.3	42
301	Microstructure evolution and mechanical properties of an intermetallic Ti-43.5Al-4Nb-1Mo-0.1B alloy after ageing below the eutectoid temperature. *International Journal of Materials Research*, **2011**, 102, 703-708	0.5	41
300	Advanced nanomechanics in the TEM: effects of thermal annealing on FIB prepared Cu samples. *Philosophical Magazine*, **2012**, 92, 3269-3289	1.6	41
299	Retrieval of crystal defect structures from HREM images by simulated evolution II. Experimental image evaluation. *Ultramicroscopy*, **1996**, 65, 217-228	3.1	41
298	Size effect in bi-crystalline micropillars with a penetrable high angle grain boundary. *Acta Materialia* , **2017**, 129, 312-320	8.4	40
297	Influence of impurity elements on the nucleation and growth of Si in high purity melt-spun Al Si-based alloys. *Philosophical Magazine*, **2012**, 92, 3789-3805	1.6	40
296	Microstructural stability and creep behavior of a lamellar TiAl based alloy with extremely fine lamellar spacing. *Intermetallics*, **2002**, 10, 459-466	3.5	40
295	Dislocation-twin boundary interaction in small scale Cu bi-crystals loaded in different crystallographic directions. *Acta Materialia*, **2017**, 129, 91-97	8.4	39
294	Microstructural size effects on the hardness of nanocrystalline TiN/amorphous-SiNx coatings prepared by magnetron sputtering. *Thin Solid Films*, **2005**, 473, 114-122	2.2	39
293	Microstructure and tribological properties of Ni-based claddings on Cu substrates. *Wear*, **1999**, 225-229, 18-26	3.5	39
292	Precipitation processes in a Mg Zn Sn alloy studied by TEM and SAXS. *Materials Science & Engineering A: Structural Materials: Properties, Microstructure and Processing*, **2008**, 494, 158-165	5.3	38
291	Effect of heat-treatments and hot-isostatic pressing on phase transformation and microstructure in a B2 containing TiAl based alloy. *Scripta Materialia*, **2000**, 42, 1065-1070	5.6	38
290	Dislocation-induced breakthrough of strength and ductility trade-off in a non-equiatomic high-entropy alloy. *Acta Materialia*, **2020**, 185, 45-54	8.4	38
289	On the segregation of Re at dislocations in the phase of Ni-based single crystal superalloys. *Materialia*, **2018**, 4, 109-114	3.2	38
288	Microstructural and mechanical characterization of an equiatomic YGdTbDyHo high entropy alloy with hexagonal close-packed structure. *Acta Materialia*, **2018**, 156, 86-96	8.4	37
287	Kinetics and driving forces of abnormal grain growth in thin Cu films. *Acta Materialia*, **2012**, 60, 2397-2406	8.4	37

286	Dislocation storage in single slip-oriented Cu micro-tensile samples: new insights via X-ray microdiffraction. *Philosophical Magazine*, **2011**, 91, 1256-1264	1.6	37
285	Mechanical size effects in a single crystalline equiatomic FeCrCoMnNi high entropy alloy. *Scripta Materialia*, **2017**, 129, 52-55	5.6	36
284	Laser cladding of Co-based hardfacing on Cu substrate. *Journal of Materials Science*, **2002**, 37, 5345-5353	4.3	36
283	Internal and external stresses: In situ TEM compression of Cu bicrystals containing a twin boundary. *Scripta Materialia*, **2015**, 100, 94-97	5.6	35
282	Size-independent stresses in Al thin films thermally strained down to −100°C. *Acta Materialia*, **2007**, 55, 1941-1946	8.4	35
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280	On the influence of microcantilever pre-crack geometries on the apparent fracture toughness of brittle materials. *Acta Materialia*, **2017**, 136, 281-287	8.4	33
279	Channel cracking of γ-NiAl thin films on Si substrates. *Acta Materialia*, **2004**, 52, 2325-2336	8.4	33
278	On the origin of acoustic emission during room temperature compressive deformation of a γ-TiAl based alloy. *Intermetallics*, **2000**, 8, 823-830	3.5	32
277	An elevated temperature study of a Ti adhesion layer on polyimide. *Thin Solid Films*, **2013**, 531, 354-361	2.2	31
276	Expected and unexpected plastic behavior at the micron scale: An in situ Laue tensile study. *Acta Materialia*, **2012**, 60, 1252-1258	8.4	31
275	Iron Aluminides. *Annual Review of Materials Research*, **2019**, 49, 297-326	12.8	30
274	Deformation mechanisms in micron-sized PST TiAl compression samples: Experiment and model. *Acta Materialia*, **2011**, 59, 3410-3421	8.4	30
273	Visualizing the Behavior of Dislocations—Seeing is Believing. *MRS Bulletin*, **2008**, 33, 122-131	3.2	30
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271	Dislocation dynamics in sub-micron confinement: recent progress in Cu thin film plasticity. *International Journal of Materials Research*, **2002**, 93, 383-391		30
270	Tensile behaviour of micro-sized copper wires studied using a novel fibre tensile module. *International Journal of Materials Research*, **2008**, 99, 716-724	0.5	29
269	Bonding at copper–alumina interfaces established by different surface treatments: a critical review. *Journal of Materials Science*, **2006**, 41, 5161-5168	4.3	29

268	In situ TEM observation of dislocation motion in thermally strained Al nanowires. *Acta Materialia*, **2002**, 50, 5033-5047	8.4	29
267	Dislocation interaction and twinning-induced plasticity in face-centered cubic Fe-Mn-C micro-pillars. *Acta Materialia*, **2017**, 132, 162-173	8.4	28
266	Microcompression and cyclic deformation behaviors of coaxial copper bicrystals with a single twin boundary. *Scripta Materialia*, **2013**, 69, 199-202	5.6	28
265	Stress intensity factor dependence on anisotropy and geometry during micro-fracture experiments. *Scripta Materialia*, **2017**, 127, 76-78	5.6	28
264	In Situ TEM Microcompression of Single and Bicrystalline Samples: Insights and Limitations. *Jom*, **2015**, 67, 1704-1712	2.1	28
263	Effects of thickness on the characteristic length scale of dislocation plasticity in Ag thin films. *Acta Materialia*, **2001**, 49, 3597-3607	8.4	28
262	Dislocation slip transmission through a coherent Σ3{111} copper twin boundary: Strain rate sensitivity, activation volume and strength distribution function. *Acta Materialia*, **2018**, 161, 412-419	8.4	28
261	Microstructural evolution and solid state dewetting of epitaxial Al thin films on sapphire (αAl2O3). *Acta Materialia*, **2017**, 133, 356-366	8.4	27
260	Importance of dislocation pile-ups on the mechanical properties and the Bauschinger effect in microcantilevers. *Journal of Materials Research*, **2015**, 30, 791-797	2.5	27
259	Temperature dependent transition of intragranular plastic to intergranular brittle failure in electrodeposited Cu micro-tensile samples. *Materials Science & Engineering A: Structural Materials: Properties, Microstructure and Processing*, **2014**, 618, 398-405	5.3	27
258	Stress, Sheet Resistance, and Microstructure Evolution of Electroplated Cu Films During Self-Annealing. *IEEE Transactions on Device and Materials Reliability*, **2010**, 10, 47-54	1.6	27
257	Experimental studies on epitaxially grown TiN and VN films. *Thin Solid Films*, **2007**, 516, 369-373	2.2	27
256	Interfacial nanophases stabilize nanotwins in high-entropy alloys. *Acta Materialia*, **2020**, 185, 218-232	8.4	27
255	Oxygen-mediated deformation and grain refinement in Cu-Fe nanocrystalline alloys. *Acta Materialia* , **2019**, 166, 281-293	8.4	27
254	Segregation-Induced Nanofaceting Transition at an Asymmetric Tilt Grain Boundary in Copper. *Physical Review Letters*, **2018**, 121, 255502	7.4	27
253	Formation of eta carbide in ferrous martensite by room temperature aging. *Acta Materialia*, **2018**, 158, 297-312	8.4	26
252	Damage evolution during cyclic tension□tension loading of micron-sized Cu lines. *Acta Materialia*, **2014**, 67, 297-307	8.4	26
251	Cyclic bending experiments on free-standing Cu micron lines observed by electron backscatter diffraction. *Acta Materialia*, **2015**, 83, 460-469	8.4	26

250	Investigation of the fatigue behavior of Al thin films with different microstructure. *Materials Science & Engineering A: Structural Materials: Properties, Microstructure and Processing*, **2010**, 527, 7757-7763	5.3	26
249	Equilibrium Amorphous Silicon–Calcium–Oxygen Films at Interfaces in Copper–Alumina Composites Prepared by Melt Infiltration. *Journal of the American Ceramic Society*, **2001**, 84, 623-630	3.8	26
248	Fracture toughness of Mo2BC thin films: Intrinsic toughness versus system toughening. *Materials and Design*, **2018**, 154, 20-27	8.1	25
247	Dynamic observation of Al thin films plastically strained in a TEM. *Materials Science & Engineering A: Structural Materials: Properties, Microstructure and Processing*, **2001**, 309-310, 463-467	5.3	25
246	Comparing small scale plasticity of copper-chromium nanolayered and alloyed thin films at elevated temperatures. *Acta Materialia*, **2015**, 93, 175-186	8.4	24
245	Are Mo2BC nanocrystalline coatings damage resistant? Insights from comparative tension experiments. *Surface and Coatings Technology*, **2016**, 289, 213-218	4.4	24
244	In Situ Laue: Instrumental Setup for the Deformation of Micron Sized Samples. *Advanced Engineering Materials*, **2011**, 13, 837-844	3.5	24
243	Structural characterization of a Cu/MgO(001) interface using CS-corrected HRTEM. *Thin Solid Films*, **2010**, 519, 1662-1667	2.2	24
242	Strain compensation by twinning in Au thin films: Experiment and model. *Acta Materialia*, **2007**, 55, 6659–6665	8.4	24
241	Influence of external and internal length scale on the flow stress of copper. *International Journal of Materials Research*, **2007**, 98, 1047-1053	0.5	24
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239	Formation of dislocation networks in a coherent Cu Σ3(1 1 1) twin boundary. *Scripta Materialia*, **2015**, 102, 71-74	5.6	23
238	Investigation of reversible plasticity in a micron-sized, single crystalline copper bending beam by X-ray Laue diffraction. *Philosophical Magazine*, **2012**, 92, 3231-3242	1.6	23
237	The effect of film thickness variations in periodic cracking: Analysis and experiments. *Surface and Coatings Technology*, **2011**, 206, 1830-1836	4.4	23
236	Novel temperature dependent tensile test of freestanding copper thin film structures. *Review of Scientific Instruments*, **2012**, 83, 064702	1.7	23
235	Measurement of coherency states of metal–ceramic interfaces by HREM image processing. *Physica Status Solidi A*, **1995**, 150, 77-87		23
234	Crystal-Glass High-Entropy Nanocomposites with Near Theoretical Compressive Strength and Large Deformability. *Advanced Materials*, **2020**, 32, e2002619	24	22
233	Influence of inclined twin boundaries on the deformation behavior of Cu micropillars. *Materials Science & Engineering A: Structural Materials: Properties, Microstructure and Processing*, **2015**, 642, 65-70	5.3	21

232	Study of nanometer-scaled lamellar microstructure in a Ti45Al7.5Nb alloy Experiments and modeling. *Intermetallics*, **2010**, 18, 509-517	3.5	21
231	Stress-controlled fatigue behaviour of micro-sized polycrystalline copper wires. *Materials Science & Engineering A: Structural Materials: Properties, Microstructure and Processing*, **2009**, 515, 71-78	5.3	21
230	Micron-sized fracture experiments on amorphous SiOx films and SiOx/SiNx multi-layers. *Thin Solid Films*, **2010**, 518, 5796-5801	2.2	21
229	A microindentation method for estimating interfacial shear strength and its use in studying the influence of titanium transition layers on the interface strength of epitaxial copper films on sapphire. *Acta Materialia*, **1997**, 45, 489-499	8.4	21
228	Transmission electron microscopy of fluorapatite-gelatine composite particles prepared using focused ion beam milling. *Journal of Microscopy*, **2004**, 214, 208-12	1.9	21
227	Sample Preparation by Metallography and Focused Ion Beam for Nanomechanical Testing. *Praktische Metallographie/Practical Metallography*, **2012**, 49, 343-355	0.3	21
226	Electronic hybridisation implications for the damage-tolerance of thin film metallic glasses. *Scientific Reports*, **2016**, 6, 36556	4.9	21
225	On the nature of twin boundary-associated strengthening in Fe-Mn-C steel. *Scripta Materialia*, **2018**, 156, 27-31	5.6	20
224	Advances in in situ nanomechanical testing. *MRS Bulletin*, **2019**, 44, 438-442	3.2	19
223	Transition from shear to stress-assisted diffusion of copper chromium nanolayered thin films at elevated temperatures. *Acta Materialia*, **2015**, 100, 73-80	8.4	19
222	Fracture toughness of intermetallic Cu6Sn5 in lead-free solder microelectronics. *Scripta Materialia*, **2016**, 123, 38-41	5.6	19
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220	Aggregation control of Ru and Ir nanoparticles by tunable aryl alkyl imidazolium ionic liquids. *Nanoscale*, **2019**, 11, 4073-4082	7.7	19
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218	The peculiarity of the metal-ceramic interface. *Scientific Reports*, **2015**, 5, 11460	4.9	18
217	Influence of composition and crystal structure on the fracture toughness of NbCo2 Laves phase studied by micro-cantilever bending tests. *Materials and Design*, **2018**, 145, 116-121	8.1	18
216	Insights into the atomic and electronic structure triggered by ordered nitrogen vacancies in CrN. *Physical Review B*, **2013**, 87,	3.3	18
215	Fracture behavior of nanostructured heavily cold drawn pearlitic steel wires before and after annealing. *Materials Science & Engineering A: Structural Materials: Properties, Microstructure and Processing*, **2017**, 707, 164-171	5.3	18

214	Electrical properties and structure of grain boundaries in n-conducting BaTiO3 ceramics. *Journal of the European Ceramic Society*, **2011**, 31, 763-771	6	18
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212	Nanotribology in austenite: Plastic plowing and crack formation. *Wear*, **2015**, 338-339, 436-440	3.5	17
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210	Strain rate dependence of the slip transfer through a penetrable high angle grain boundary in copper. *Scripta Materialia*, **2017**, 138, 88-91	5.6	16
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207	Microstructure and adhesion of as-deposited and annealed Cu/Ti films on polyimide. *International Journal of Materials Research*, **2011**, 102, 1-6	0.5	16
206	Atomic scale configuration of planar defects in the Nb-rich C14 Laves phase NbFe2. *Acta Materialia*, **2020**, 183, 362-376	8.4	16
205	Adhesion measurement of a buried Cr interlayer on polyimide. *Philosophical Magazine*, **2015**, 95, 1982-1991	1.6	15
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202	Annealing induced void formation in epitaxial Al thin films on sapphire (Al2O3). *Acta Materialia*, **2017**, 140, 355-365	8.4	15
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200	Interface failure and adhesion measured by focused ion beam cutting of metal/polymer interfaces. *Philosophical Magazine Letters*, **2011**, 91, 530-536	1	15
199	Deformation twinning in Ni-Mn-Ga micropillars with 10M martensite. *Journal of Applied Physics*, **2009**, 106, 53906	2.5	15
198	Can micro-compression testing provide stress–strain data for thin films?. *Thin Solid Films*, **2009**, 518, 1517–1521	1.7	15
197	Interface structure of epitaxial (111) VN films on (111) MgO substrates. *Thin Solid Films*, **2008**, 517, 1177–1181	1.7	15

196	Thermal stability of Ti and Pt nanowires manufactured by Ga+ focused ion beam. *Journal of Microscopy*, **2004**, 214, 252-60	1.9	15
195	Experimental conditions affecting the measured fracture toughness at the microscale: Notch geometry and crack extension measurement. *Materials and Design*, **2020**, 191, 108582	8.1	14
194	Size and orientation dependent mechanical behavior of body-centered tetragonal Sn at 0.6 of the melting temperature. *Acta Materialia*, **2016**, 115, 76-82	8.4	14
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192	Elastoplastic buckling as source of misinterpretation of micropillar tests. *Acta Materialia*, **2013**, 61, 4996-5007	8.4	14
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189	Precipitation hardening in Mg-Z-Sn alloys with minor additions of Ca and Si. *International Journal of Materials Research*, **2005**, 96, 1081-1087		14
188	In situ atomic-scale observation of oxidation and decomposition processes in nanocrystalline alloys. *Nature Communications*, **2018**, 9, 946	17.4	13
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